

# ON Semiconductor

## Is Now

# onsemi™

To learn more about onsemi™, please visit our website at  
[www.onsemi.com](http://www.onsemi.com)

---

**onsemi** and **onsemi** and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi** product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner. Other names and brands may be claimed as the property of others.

# MC74AC299, MC74ACT299



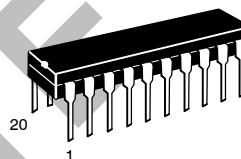
ON Semiconductor®

<http://onsemi.com>

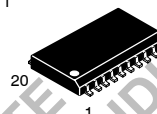
## 8-Input Universal Shift/Storage Register with Common Parallel I/O Pins

The MC74AC299/74ACT299 is an 8-bit universal shift/storage register with 3-state outputs. Four modes of operation are possible: hold (store), shift left, shift right and load data. The parallel load inputs and flip-flop outputs are multiplexed to reduce the total number of package pins. Additional outputs are provided for flip-flops Q<sub>0</sub>, Q<sub>7</sub> to allow easy serial cascading. A separate active LOW Master Reset is used to reset the register.

- Common Parallel I/O for Reduced Pin Count
- Additional Serial Inputs and Outputs for Expansion
- Four Operating Modes: Shift Left, Shift Right, Load and Store
- 3-State Outputs for Bus-Oriented Applications
- Outputs Source/Sink 24 mA
- 'ACT299 Has TTL Compatible Inputs
- **These devices are available in Pb-free package(s). Specifications herein apply to both standard and Pb-free devices. Please see our website at [www.onsemi.com](http://www.onsemi.com) for specific Pb-free orderable part numbers, or contact your local ON Semiconductor sales office or representative.**



PDIP-20  
N SUFFIX  
CASE 738



SO-20  
DW SUFFIX  
CASE 751

### ORDERING INFORMATION

Device	Package	Shipping
MC74AC299N	PDIP-20	18 Units/Rail
MC74ACT299N	PDIP-20	18 Units/Rail
MC74AC299DW	SOIC-20	38 Units/Rail
MC74AC299DWR2	SOIC-20	1000 Tape & Reel
MC74ACT299DW	SOIC-20	38 Units/Rail
MC74ACT299DWR2	SOIC-20	1000 Tape & Reel

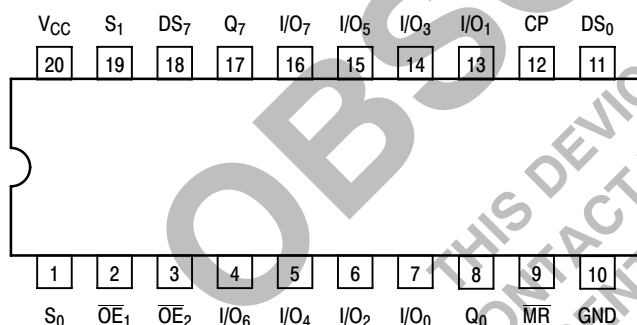


Figure 1. Pinout: 20-Lead Packages Conductors (Top View)

### DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 9 of this data sheet.

### PIN ASSIGNMENT

PIN	FUNCTION
CP	Clock Pulse Input
DS <sub>0</sub>	Serial Data Input for Right Shift
DS <sub>7</sub>	Serial Data Input for Left Shift
S <sub>0</sub> , S <sub>1</sub>	Mode Select Inputs
$\overline{MR}$	Asynchronous Master Reset
$\overline{OE}_1$ , $\overline{OE}_2$	3-State Output Enable Inputs
I/O <sub>0</sub> -I/O <sub>7</sub>	Parallel Data Inputs or 3-State Parallel Outputs
Q <sub>0</sub> , Q <sub>7</sub>	Serial Outputs

# MC74AC299, MC74ACT299

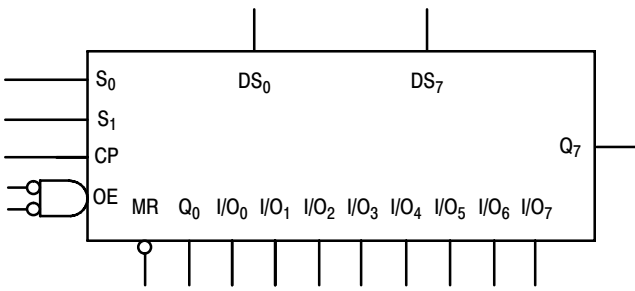
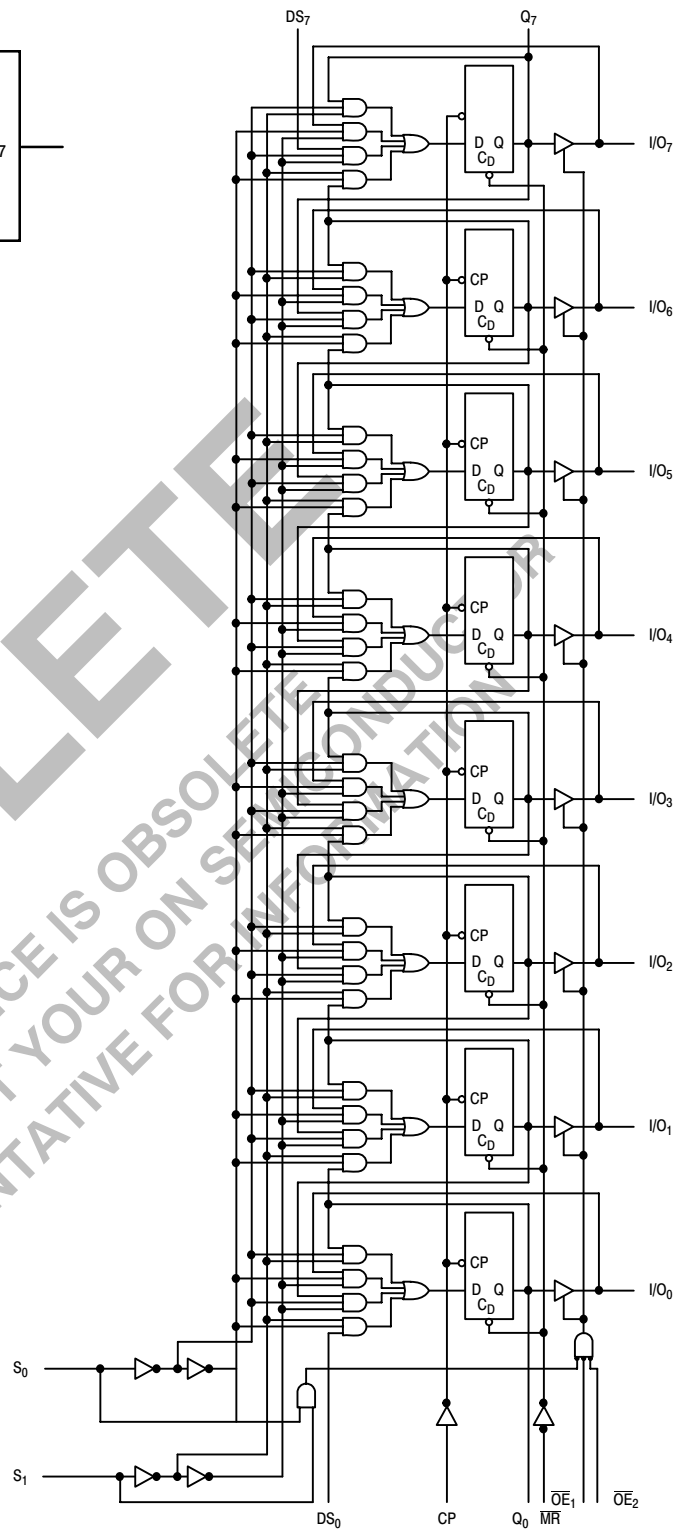


Figure 2. Logic Symbol



NOTE: That this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

# MC74AC299, MC74ACT299

## FUNCTIONAL DESCRIPTION

The MC74AC299/74ACT299 contains eight edge-triggered D-type flip-flops and the interstage logic necessary to perform synchronous shift left, shift right, parallel load and hold operations. The type of operation is determined by  $S_0$  and  $S_1$ , as shown in the Truth Table. All flip-flop outputs are brought out through 3-state buffers to separate I/O pins that also serve as data inputs in the parallel load mode.  $Q_0$  and  $Q_7$  are also brought out on other pins for expansion in serial shifting of longer words.

A LOW signal on  $\overline{MR}$  overrides the Select and CP inputs and resets the flip-flops. All other state changes are initiated by the rising edge of the clock. Inputs can change when the clock is in either state provided only that the recommended setup and hold times, relative to the rising edge of CP, are observed.

A HIGH signal on either  $\overline{OE}_1$  or  $\overline{OE}_2$  disables the 3-state buffers and puts the I/O pins in the high impedance state. In this condition the shift, hold, load and reset operations can still occur. The 3-state buffers are also disabled by HIGH signals on both  $S_0$  and  $S_1$  in preparation for a parallel load operation.

## TRUTH TABLE

Inputs				Response
MR	$S_1$	$S_0$	CP	
L	X	X	X	Asynchronous Reset; $Q_0-Q_7 = \text{LOW}$
H	H	H	$\lrcorner$	Parallel Load; $I/O_n \rightarrow Q_n$
H	L	H	$\lrcorner$	Shift Rights; $DS_0 \rightarrow Q_0, Q_0 \rightarrow Q_1, \text{etc.}$
H	H	L	$\lrcorner$	Shift Left; $DS_7 \rightarrow Q_7, Q_7 \rightarrow Q_6, \text{etc.}$
H	L	L	X	Hold

H = HIGH Voltage Level  
 L = LOW Voltage Level  
 X = Immaterial  
 $\lrcorner$  = LOW-to-HIGH Transition

## MAXIMUM RATINGS\*

Symbol	Parameter	Value	Unit
$V_{CC}$	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
$V_{IN}$	DC Input Voltage (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
$V_{OUT}$	DC Output Voltage (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
$I_{IN}$	DC Input Current, per Pin	$\pm 20$	mA
$I_{OUT}$	DC Output Sink/Source Current, per Pin	$\pm 50$	mA
$I_{CC}$	DC $V_{CC}$ or GND Current per Output Pin	$\pm 50$	mA
$T_{stg}$	Storage Temperature	-65 to +150	$^{\circ}\text{C}$

\*Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit	
$V_{CC}$	Supply Voltage	'AC	2.0	5.0	6.0	V
		'ACT	4.5	5.0	5.5	
$V_{IN}, V_{OUT}$	DC Input Voltage, Output Voltage (Ref. to GND)	0	-	$V_{CC}$	V	
$t_r, t_f$	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	$V_{CC} @ 3.0 \text{ V}$	-	150	-	ns/V
		$V_{CC} @ 4.5 \text{ V}$	-	40	-	
		$V_{CC} @ 5.5 \text{ V}$	-	25	-	
$t_r, t_f$	Input Rise and Fall Time (Note 2) 'ACT Devices except Schmitt Inputs	$V_{CC} @ 4.5 \text{ V}$	-	10	-	ns/V
		$V_{CC} @ 5.5 \text{ V}$	-	8.0	-	
$T_J$	Junction Temperature (PDIP)	-	-	140	$^{\circ}\text{C}$	
$T_A$	Operating Ambient Temperature Range	-40	25	85	$^{\circ}\text{C}$	
$I_{OH}$	Output Current - High	-	-	-24	mA	
$I_{OL}$	Output Current - Low	-	-	24	mA	

- $V_{IN}$  from 30% to 70%  $V_{CC}$ ; see individual Data Sheets for devices that differ from the typical input rise and fall times.
- $V_{IN}$  from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

# MC74AC299, MC74ACT299

## DC CHARACTERISTICS

Symbol	Parameter	V <sub>CC</sub> (V)	74AC		74AC		Unit	Conditions
			T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to +85°C			
			Typ	Guaranteed Limits				
V <sub>IH</sub>	Minimum High Level Input Voltage	3.0	1.5	2.1	2.1		V	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V
		4.5	2.25	3.15	3.15			
		5.5	2.75	3.85	3.85			
V <sub>IL</sub>	Maximum Low Level Input Voltage	3.0	1.5	0.9	0.9		V	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V
		4.5	2.25	1.35	1.35			
		5.5	2.75	1.65	1.65			
V <sub>OH</sub>	Minimum High Level Output Voltage	3.0	2.99	2.9	2.9		V	I <sub>OUT</sub> = -50 μA
		4.5	4.49	4.4	4.4			
		5.5	5.49	5.4	5.4			
		3.0	-	2.56	2.46		V	*V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> -12 mA I <sub>OH</sub> -24 mA -24 mA
		4.5	-	3.86	3.76			
5.5	-	4.86	4.76					
V <sub>OL</sub>	Maximum Low Level Output Voltage	3.0	0.002	0.1	0.1		V	I <sub>OUT</sub> = 50 μA
		4.5	0.001	0.1	0.1			
		5.5	0.001	0.1	0.1			
		3.0	-	0.36	0.44		V	*V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> 12 mA I <sub>OL</sub> 24 mA 24 mA
		4.5	-	0.36	0.44			
5.5	-	0.36	0.44					
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	-	±0.1	±1.0		μA	V <sub>I</sub> = V <sub>CC</sub> , GND
I <sub>OZT</sub>	Maximum 3-State Current	5.5	-	±0.6	±6.0		μA	V <sub>I</sub> (OE) = V <sub>IL</sub> , V <sub>IH</sub> V <sub>I</sub> = V <sub>CC</sub> , GND V <sub>O</sub> = V <sub>CC</sub> , GND
I <sub>OLD</sub>	†Minimum Dynamic Output Current	5.5	-	-	75		mA	V <sub>OLD</sub> = 1.65 V Max
I <sub>OHD</sub>		5.5	-	-	-75		mA	V <sub>OHD</sub> = 3.85 V Min
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	-	8.0	80		μA	V <sub>IN</sub> = V <sub>CC</sub> or GND

\*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I<sub>IN</sub> and I<sub>CC</sub> @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V<sub>CC</sub>.

## AC CHARACTERISTICS (For Figures and Waveforms – See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

Symbol	Parameter	V <sub>CC</sub> * (V)	74AC			74AC		Unit	Fig. No.
			T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF			T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF			
			Min	Typ	Max	Min	Max		
f <sub>max</sub>	Maximum Input Frequency	3.3	90	-	-	80	-	MHz	3-3
		5.0	130	-	-	105	-		
t <sub>PLH</sub>	Propagation Delay CP to Q <sub>0</sub> or Q <sub>7</sub>	3.3	8.5	-	20.5	7.0	22	ns	3-6
		5.0	5.5	-	14	4.5	15		
t <sub>PHL</sub>	Propagation Delay CP to Q <sub>0</sub> or Q <sub>7</sub>	3.3	8.5	-	21.5	7.0	23	ns	3-6
		5.0	5.5	-	14.5	5.0	16		

\*Voltage Range 3.3 V is 3.3 V ±0.3 V.

Voltage Range 5.0 V is 5.0 V ±0.5 V.

# MC74AC299, MC74ACT299

**AC CHARACTERISTICS** (For Figures and Waveforms – See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

Symbol	Parameter	V <sub>CC</sub> * (V)	74AC			74AC		Unit	Fig. No.
			T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF			T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF			
			Min	Typ	Max	Min	Max		
t <sub>PLH</sub>	Propagation Delay CP to I/O <sub>n</sub>	3.3 5.0	9.0 6.0	– –	20.5 14.5	7.5 5.0	22.5 16	ns	3–6
t <sub>PHL</sub>	Propagation Delay CP to I/O <sub>n</sub>	3.3 5.0	10 6.5	– –	23 16	8.5 6.0	24.5 17.5	ns	3–6
t <sub>PHL</sub>	Propagation Delay MR to Q <sub>0</sub> or Q <sub>7</sub>	3.3 5.0	9.0 5.5	– –	22.5 15.5	7.5 5.0	25.0 17.0	ns	3–6
t <sub>PHL</sub>	Propagation Delay MR to I/O <sub>n</sub>	3.3 5.0	9.0 5.5	– –	21.5 15.0	7.5 5.0	24.0 16.5	ns	3–6
t <sub>PZH</sub>	Output Enable Time OE to I/O <sub>n</sub>	3.3 5.0	7.0 4.5	– –	18 12.5	6.0 4.0	19.5 13.5	ns	3–7
t <sub>PZL</sub>	Output Enable Time OE to I/O <sub>n</sub>	3.3 5.0	7.0 5.0	– –	18 12.5	6.0 4.0	20.5 14	ns	3–8
t <sub>PHZ</sub>	Output Disable Time OE to I/O <sub>n</sub>	3.3 5.0	6.5 3.5	– –	18.5 14	5.5 3.0	19.5 15	ns	3–7
t <sub>PLZ</sub>	Output Disable Time OE to I/O <sub>n</sub>	3.3 5.0	5.5 3.5	– –	17 12.5	4.5 2.0	19 13.5	ns	3–8

\*Voltage Range 3.3 V is 3.3 V ±0.3 V.  
Voltage Range 5.0 V is 5.0 V ±0.5 V.

## AC OPERATING REQUIREMENTS

Symbol	Parameter	V <sub>CC</sub> * (V)	74AC		74AC		Unit	Fig. No.
			T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF		T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF			
			Typ	Guaranteed Minimum				
t <sub>s</sub>	Setup Time, HIGH or LOW S <sub>0</sub> or S <sub>1</sub> to CP	3.3 5.0	– –	8.0 5.0	8.5 5.5	ns	3–9	
t <sub>h</sub>	Hold Time, HIGH or LOW S <sub>0</sub> or S <sub>1</sub> to CP	3.3 5.0	– –	0.5 1.0	0.5 1.0	ns	3–9	
t <sub>s</sub>	Setup Time, HIGH or LOW I/O <sub>n</sub> to CP	3.3 5.0	– –	5.5 3.5	6.0 4.0	ns	3–9	
t <sub>h</sub>	Hold Time, HIGH or LOW I/O <sub>n</sub> to CP	3.3 5.0	– –	0 1.0	0 1.0	ns	3–9	
t <sub>s</sub>	Setup Time, HIGH or LOW DS <sub>0</sub> or DS <sub>7</sub> to CP	3.3 5.0	– –	6.5 4.0	7.0 4.5	ns	3–6	
t <sub>h</sub>	Hold Time, HIGH or LOW DS <sub>0</sub> or DS <sub>7</sub> to CP	3.3 5.0	– –	0 1.0	0.5 1.0	ns	3–6	
t <sub>w</sub>	CP Pulse Width, LOW	3.3 5.0	– –	4.5 3.5	5.0 3.5	ns	3–6	
t <sub>w</sub>	MR Pulse Width, LOW	3.3 5.0	– –	4.5 3.5	5.0 3.5	ns	3–9	
t <sub>rec</sub>	Recovery Time MR to CP	3.3 5.0	– –	1.5 1.5	1.5 1.5	ns	3–9	

\*Voltage Range 3.3 V is 3.3 V ±0.3 V.  
Voltage Range 5.0 V is 5.0 V ±0.5 V.

# MC74AC299, MC74ACT299

## DC CHARACTERISTICS

Symbol	Parameter	V <sub>CC</sub> (V)	74ACT		74ACT		Unit	Conditions
			T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to +85°C			
			Typ	Guaranteed Limits				
V <sub>IH</sub>	Minimum High Level Input Voltage	4.5	1.5	2.0	2.0	V	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V	
		5.5	1.5	2.0	2.0			
V <sub>IL</sub>	Maximum Low Level Input Voltage	4.5	1.5	0.8	0.8	V	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V	
		5.5	1.5	0.8	0.8			
V <sub>OH</sub>	Minimum High Level Output Voltage	4.5	4.49	4.4	4.4	V	I <sub>OUT</sub> = -50 μA	
		5.5	5.49	5.4	5.4			
		4.5	-	3.86	3.76	V	*V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> I <sub>OH</sub> = -24 mA	
		5.5	-	4.86	4.76			
V <sub>OL</sub>	Maximum Low Level Output Voltage	4.5	0.001	0.1	0.1	V	I <sub>OUT</sub> = 50 μA	
		5.5	0.001	0.1	0.1			
		4.5	-	0.36	0.44	V	*V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> I <sub>OL</sub> = 24 mA	
		5.5	-	0.36	0.44			
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μA	V <sub>I</sub> = V <sub>CC</sub> , GND	
I <sub>OZT</sub>	Maximum 3-State Current	5.5	-	±0.6	±6.0	μA	V <sub>I</sub> (OE) = V <sub>IL</sub> , V <sub>IH</sub> V <sub>I</sub> = V <sub>CC</sub> , GND V <sub>O</sub> = V <sub>CC</sub> , GND	
ΔI <sub>CCT</sub>	Additional Max. I <sub>CC</sub> /Input	5.5	0.6	-	1.5	mA	V <sub>I</sub> = V <sub>CC</sub> - 2.1 V	
I <sub>OLD</sub>	†Minimum Dynamic Output Current	5.5	-	-	75	mA	V <sub>OLD</sub> = 1.65 V Max	
I <sub>OHD</sub>		5.5	-	-	-75	mA	V <sub>OHD</sub> = 3.85 V Min	
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	-	8.0	80	μA	V <sub>IN</sub> = V <sub>CC</sub> or GND	

\*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

# MC74AC299, MC74ACT299

**AC CHARACTERISTICS** (For Figures and Waveforms – See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

Symbol	Parameter	V <sub>CC</sub> * (V)	74ACT			74ACT		Unit	Fig. No.
			T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF			T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF			
			Min	Typ	Max	Min	Max		
f <sub>max</sub>	Maximum Input Frequency	5.0	120	–	–	110	–	MHz	3–3
t <sub>PLH</sub>	Propagation Delay CP to Q <sub>0</sub> or Q <sub>7</sub>	5.0	4.0	–	12.5	3.0	14	ns	3–6
t <sub>PHL</sub>	Propagation Delay CP to Q <sub>0</sub> or Q <sub>7</sub>	5.0	4.0	–	13.5	3.5	15	ns	3–6
t <sub>PLH</sub>	Propagation Delay CP to I/O <sub>n</sub>	5.0	4.5	–	12.5	4.5	13.5	ns	3–6
t <sub>PHL</sub>	Propagation Delay CP to I/O <sub>n</sub>	5.0	5.0	–	15	4.5	16.5	ns	3–6
t <sub>PHL</sub>	Propagation Delay M <sub>R</sub> to Q <sub>0</sub> or Q <sub>7</sub>	5.0	4.0	–	15	4.0	18	ns	3–6
t <sub>PHL</sub>	Propagation Delay M <sub>R</sub> to I/O <sub>n</sub>	5.0	4.0	–	14.5	3.5	17.5	ns	3–6
t <sub>PZH</sub>	Output Enable Time OE to I/O <sub>n</sub>	5.0	2.5	–	12	1.5	13	ns	3–7
t <sub>PZL</sub>	Output Enable Time OE to I/O <sub>n</sub>	5.0	2.0	–	12	1.5	13.5	ns	3–8
t <sub>PHZ</sub>	Output Disable Time OE to I/O <sub>n</sub>	5.0	2.0	–	12.5	2.0	13.5	ns	3–7
t <sub>PLZ</sub>	Output Disable Time OE to I/O <sub>n</sub>	5.0	2.5	–	11.5	2.0	12.5	ns	3–8

\*Voltage Range 5.0 V is 5.0 V ±0.5 V.



# MC74AC299, MC74ACT299

## AC OPERATING REQUIREMENTS

Symbol	Parameter	V <sub>CC</sub> * (V)	74ACT		74ACT		Unit	Fig. No.
			T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF		T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF			
			Typ	Guaranteed Minimum				
t <sub>s</sub>	Setup Time, HIGH or LOW S <sub>0</sub> or S <sub>1</sub> to CP	5.0	-	5.0	5.5	ns	3-9	
t <sub>h</sub>	Hold Time, HIGH or LOW S <sub>0</sub> or S <sub>1</sub> to CP	5.0	-	1.0	1.0	ns	3-9	
t <sub>s</sub>	Setup Time, HIGH or LOW I/O <sub>n</sub> to CP	5.0	-	4.0	4.5	ns	3-9	
t <sub>h</sub>	Hold Time, HIGH or LOW I/O <sub>n</sub> to CP	5.0	-	1.0	1.0	ns	3-9	
t <sub>s</sub>	Setup Time, HIGH or LOW DS <sub>0</sub> or DS <sub>7</sub> to CP	5.0	-	4.5	5.0	ns	3-6	
t <sub>h</sub>	Hold Time, HIGH or LOW DS <sub>0</sub> or DS <sub>7</sub> to CP	5.0	-	1.0	1.0	ns	3-6	
t <sub>w</sub>	CP Pulse Width HIGH or LOW	5.0	-	4.0	4.5	ns	3-9	
t <sub>w</sub>	MR Pulse Width, LOW	5.0	-	3.5	3.5	ns	3-9	
t <sub>rec</sub>	Recovery Time MR to CP	5.0	-	1.5	1.5	ns	3-9	

\*Voltage Range 5.0 V is 5.0 V ±0.5 V.

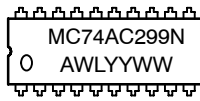
## CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C <sub>IN</sub>	Input Capacitance	4.5	pF	V <sub>CC</sub> = 5.0 V
C <sub>PD</sub>	Power Dissipation Capacitance	170	pF	V <sub>CC</sub> = 5.0 V

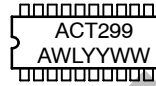
# MC74AC299, MC74ACT299

## MARKING DIAGRAMS

PDIP-20



SO-20



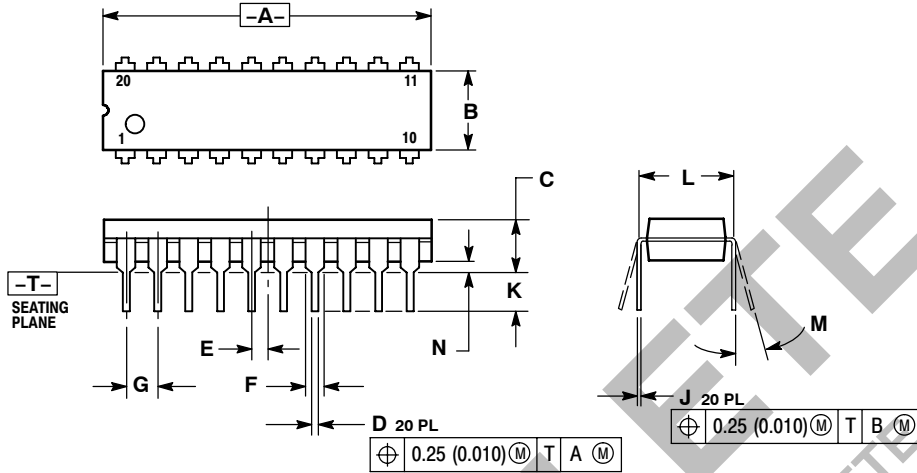
A = Assembly Location  
WL, L = Wafer Lot  
YY, Y = Year  
WW, W = Work Week

**OBSOLETE**  
THIS DEVICE IS OBSOLETE  
PLEASE CONTACT YOUR ON SEMICONDUCTOR  
REPRESENTATIVE FOR INFORMATION

# MC74AC299, MC74ACT299

## PACKAGE DIMENSIONS

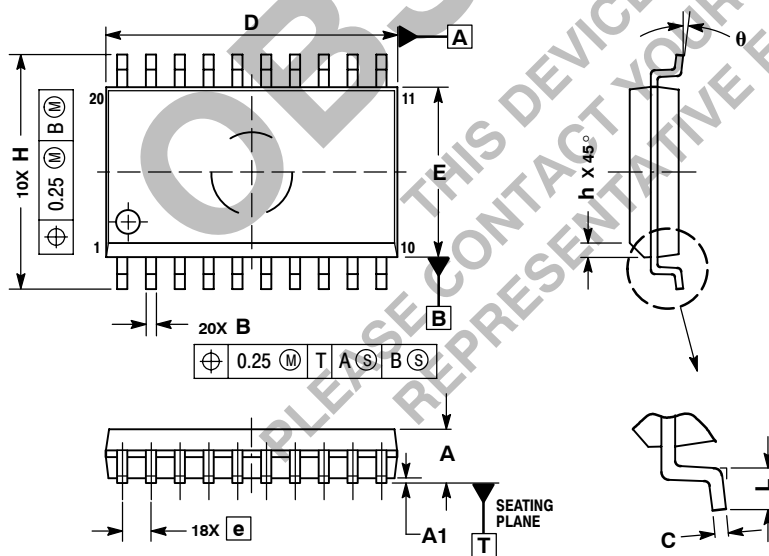
**PDIP-20  
N SUFFIX**  
20 PIN PLASTIC DIP PACKAGE  
CASE 738-03  
ISSUE E



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.010	1.070	25.66	27.17
B	0.240	0.260	6.10	6.60
C	0.150	0.180	3.81	4.57
D	0.015	0.022	0.39	0.55
E	0.050 BSC		1.27 BSC	
F	0.050	0.070	1.27	1.77
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.140	2.80	3.55
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

**SO-20  
DW SUFFIX**  
20 PIN PLASTIC SOIC PACKAGE  
CASE 751D-05  
ISSUE F



- NOTES:
1. DIMENSIONS ARE IN MILLIMETERS.
  2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
  5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
B	0.35	0.49
C	0.23	0.32
D	12.65	12.95
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
$\theta$	0°	7°

**OBSOLETE**  
THIS DEVICE IS OBSOLETE  
PLEASE CONTACT YOUR ON SEMICONDUCTOR  
REPRESENTATIVE FOR INFORMATION

**ON Semiconductor** and **ON** are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

##### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5773-3850

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local  
Sales Representative